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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Chad A. Cobbley et al.

Serial No.: 10/770,941

Filed: February 03, 2004

For: STACKED DIE MODULE AND  
TECHNIQUES FOR FORMING A  
STACKED DIE MODULE

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Group Art Unit: 2813

Examiner: Blum, David S.

Atty Docket: MICS:0078—2 (FLE)  
(01-0752.02)

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37 C.F.R. 1.8

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May 23, 2005

Date

*Kerri Hyland*  
Kerri Hyland

Sir:

**RESPONSE AND AMENDMENT**

In response to the Final Official Action mailed on March 22, 2005, Applicants respectfully request reconsideration of the above-identified application in view of the amendments and remarks set forth below.